



**RESPONSE UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE - EXAMINING GROUP**

PATENT

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February 21, 2006
Date

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/699,256

Confirmation No. : 9603

Applicants : Chih-Chen Cho and Zhongze Wang

Filed : October 30, 2003

Attorney Docket No.: 500982.02 (30016/US/2)

Art Unit : 2822

Customer No. : 27,076

Examiner : Toniae M. Thomas

Title : METHODS FOR MAKING SEMICONDUCTOR STRUCTURES HAVING
HIGH-SPEED AREAS AND HIGH-DENSITY AREAS

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Sir:

Please amend the above-captioned patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.